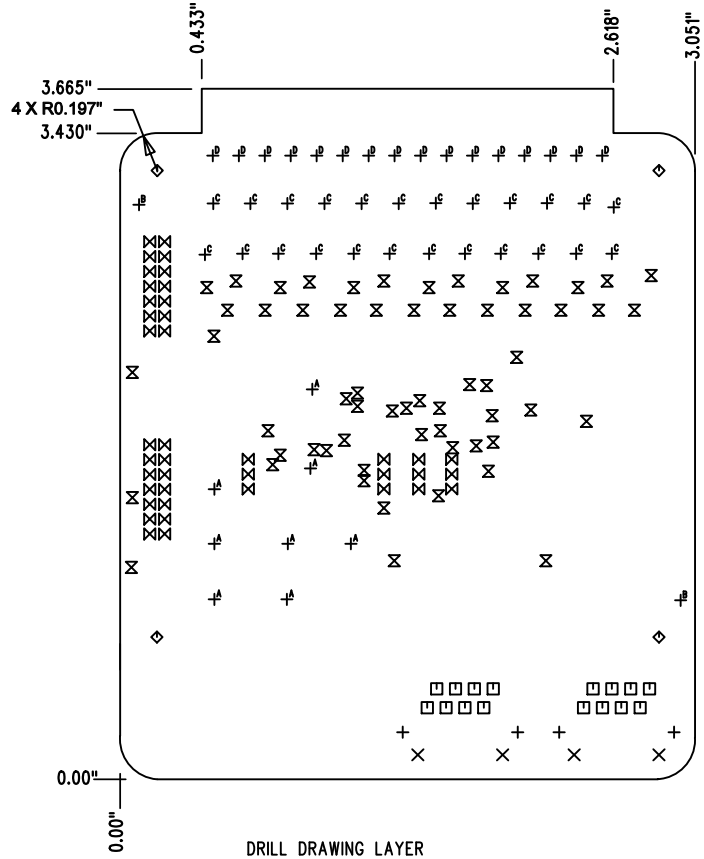


DRILL DRAWING LAYER

LINEAR TECHNOLOGY DATE: 06-15-15

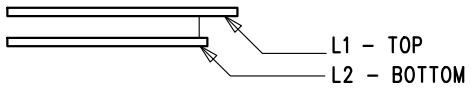
DC2259A-2- LTC6811IG-1

isoSPI 12-CELL BATTERY-STACK MONITOR

SIZE	QTY	SYM	PLATED	TOL
0.06496	4	+	YES	+/-0.003
0.12795	4	X	NO	+/-0.003
0.03819	16	□	YES	+/-0.003
0.187	4	◇	NO	+/-0.003
0.01	60	⧖	YES	+/-0.003
0.035	40	⋈	YES	+/-0.003
0.063	8	+A	YES	+/-0.003
0.07	2	+B	NO	+/-0.003
0.02	24	+C	YES	+/-0.003
0.056	16	+D	YES	+/-0.003

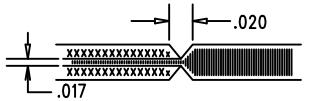
REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
–	1	2ND PROTOTYPE	CUYLER L.	06-15-15

LAYER STRUCTURE

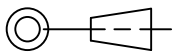


NOTES: UNLESS OTHERWISE SPECIFIED

1. FAB PER IPC-A-600.
2. MATERIAL: -LEAD FREE ASSEMBLY COMPLIANT, ISOLA FR-370HR OR EQUIVALENT.
   -FINISHED THICKNESS TO BE 0.062" +/- .005"
   -TOTAL OF 2 LAYERS WITH 2 OZ. CU ON THE OUTER LAYERS AND 1 OZ. CU ON THE INNER LAYERS.
   -FLAMMABILITY RATING: 94 V-0 MINIMUM.
3. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN. 0.00" ARE PRIMARY DATUMS.
4. DRILLING: -DRILL HOLES PER SCHEDULE. PLATE THROUGH HOLES WITH COPPER, 0.001" THICK MIN.
   -ALL HOLE SIZES ARE SPECIFIED AFTER PLATING.
   -HOLE LOCATION TOLERANCES ARE +/-0.003" IN RELATION TO CENTER
5. FINISH: -SMOBC USING LPI BOTH SIDES, COLOR GREEN.
   -GOLD IMMERSION BOTH SIDES.
   -FOR SILKSCREENS: USE WHITE NON-CONDUCTIVE INK.
6. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE. PAD SIZE CAN BE MODIFIED TO MEET END FINISH.
7. PCBS ARE TO BE RoHS COMPLIANT.
8. SCORING FOR PANELIZED PCB (PRODUCTION FAB ONLY):



UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN INCHES
TOLERANCES:
0.XX" = ±0.01"
0.XXX" = ±0.005"
INTERPRET DIM AND TOL PER ASME Y14.5M-1994
THIRD ANGLE PROJECTION



APPROVALS	
PCB DES.	AK
APP ENG.	JON M.

SCALE = NONE

LINEAR TECHNOLOGY
1630 MCCARTHY BLVD
MILPITAS, CA 95035
PH: (408)432-1900
www.linear.com

TITLE: FABRICATION DRAWING

isoSPI 12-CELL BATTERY-STACK MONITOR

SIZE	IC NO.	REV
N/A	LTC6811IG-1 DEMO CIRCUIT 2259A	2

FILENAME: DC2259A-2.PCB